

ON Semiconductor®

# ISL9V3040D3S / ISL9V3040S3S / ISL9V3040P3 / ISL9V3040S3

## EcoSPARK<sup>II</sup> 300mJ, 400V, N-Channel Ignition IGBT

#### **General Description**

The ISL9V3040D3S, ISL9V3040S3S, ISL9V3040P3, and ISL9V3040S3 are the next generation ignition IGBTs that offer outstanding SCIS capability in the space saving D-Pak (TO-252), as well as the industry standard D²-Pak (TO-263), and TO-262 and TO-220 plastic packages. This device is intended for use in automotive ignition circuits, specifically as a coil driver. Internal diodes provide voltage clamping without the need for external components.

**EcoSPARK¤** devices can be custom made to specific clamp voltages. Contact your nearest ON Semiconductor sales office for more information.

#### Formerly Developmental Type 49362

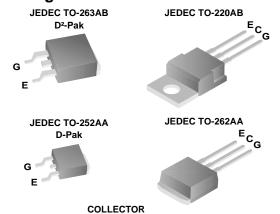
- · Automotive Ignition Coil Driver Circuits
- · Coil- On Plug Applications

#### **Features**

**Applications** 

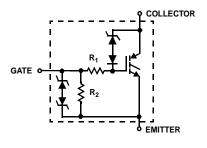
- · Space saving D-Pak package availability
- SCIS Energy = 300mJ at T<sub>1</sub> = 25°C
- · Logic Level Gate Drive

#### **Package**



(FLANGE)

### **Symbol**



#### **Device Maximum Ratings** T<sub>A</sub> = 25°C unless otherwise noted

Symbol	Parameter	Ratings	Units	
BV <sub>CER</sub>	Collector to Emitter Breakdown Voltage (I <sub>C</sub> = 1 mA)	430		
BV <sub>ECS</sub>	Emitter to Collector Voltage - Reverse Battery Condition (I <sub>C</sub> = 10 mA)	24	V	
E <sub>SCIS25</sub>	At Starting $T_J = 25$ °C, $I_{SCIS} = 14.2A$ , $L = 3.0$ mHy	300	mJ	
E <sub>SCIS150</sub>	At Starting T <sub>J</sub> = 150°C, I <sub>SCIS</sub> = 10.6A, L = 3.0 mHy	170	mJ	
I <sub>C25</sub>	Collector Current Continuous, At T <sub>C</sub> = 25°C, See Fig 9	21	Α	
I <sub>C110</sub>	Collector Current Continuous, At T <sub>C</sub> = 110°C, See Fig 9	17	Α	
$V_{GEM}$	Gate to Emitter Voltage Continuous	±10	V	
P <sub>D</sub>	Power Dissipation Total T <sub>C</sub> = 25°C	150	W	
	Power Dissipation Derating T <sub>C</sub> > 25°C	1.0	W/°C	
TJ	Operating Junction Temperature Range	-40 to 175	°C	
T <sub>STG</sub>	Storage Junction Temperature Range	-40 to 175	°C	
TL	Max Lead Temp for Soldering (Leads at 1.6mm from Case for 10s)	300	°C	
T <sub>pkg</sub>	Max Lead Temp for Soldering (Package Body for 10s)	260	°C	
ESD	Electrostatic Discharge Voltage at 100pF, 1500Ω	4	kV	

_			-	ormatio			1 .			
Device Marking		Device		ackage	Reel Size			Tape Width		antity
V3040D		ISL9V3040D3ST	TC	D-252AA	AA 330mm		16mm		2500	
V3040S		ISL9V3040S3ST	TC	D-263AB	330mm		24mm		8	300
V3040P IS		ISL9V3040P3	TO-220AA		Tube		N/A		50	
V3040S ISL9V3040S3			TC	O-262AA Tube			N/A		50	
V3040D ISL9V3040D3S T0			O-252AA Tube			N/A		75		
			D-263AB Tube			N/A		50		
	al Chai	Characteristics T <sub>A</sub> = 25°C unless otherwise noted  Parameter Test Conditions								
Symbol	<u> </u>	Test Conditions			Min	Тур	Max	Unit		
ff State	Charact	eristics								
BV <sub>CER</sub>	Collector to Emitter Breakdown Voltage			$I_C$ = 2mA, $V_{GE}$ = 0, $R_G$ = 1K $\Omega$ , See Fig. 15 $T_J$ = -40 to 150°C			370	400	430	V
BV <sub>CES</sub>	Collector	to Emitter Breakdown Vol	ltage	I <sub>C</sub> = 10mA, V <sub>GE</sub> = 0, R <sub>G</sub> = 0, See Fig. 15 T <sub>J</sub> = -40 to 150°C			390	420	450	V
BV <sub>ECS</sub>	Emitter to Collector Breakdown Voltage			$I_C = -75 \text{mA}, V_{GE} = 0 \text{V},$ $T_C = 25 ^{\circ}\text{C}$			30	-	-	V
BV <sub>GES</sub>	Gate to E	Emitter Breakdown Voltage		I <sub>GES</sub> = ± 2m	Α		±12	±14	-	V
I <sub>CER</sub>	Collector	to Emitter Leakage Curre	nt	V <sub>CER</sub> = 250		T <sub>C</sub> = 25°C	-	-	25	μΑ
		•		$R_G = 1KΩ$ , See Fig. 11		T <sub>C</sub> = 150°C	-	-	1	mA
I <sub>ECS</sub>	Emitter to Collector Leakage Current			V <sub>EC</sub> = 24V, See		T <sub>C</sub> = 25°C	-	-	1	mA
				Fig. 11		T <sub>C</sub> = 150°C	-	-	40	mA
R <sub>1</sub>	Series Gate Resistance						-	70	-	Ω
R <sub>2</sub>	Emitter Resistance				10K	-	26K	Ω		
n State (	Charact	eristics		•						•
V <sub>CE(SAT)</sub>	Collector	Collector to Emitter Saturation Voltage		$I_C = 6A$ , $T_C = 25$ °C, $V_{GE} = 4V$ See Fig. 3		-	1.25	1.60	V	
V <sub>CE(SAT)</sub>	Collector to Emitter Saturation Voltage		age	I <sub>C</sub> = 10A, T <sub>C</sub> = 15		T <sub>C</sub> = 150°C, See Fig. 4	-	1.58	1.80	V
V <sub>CE(SAT)</sub>	Collector to Emitter Saturation Voltage		age	$I_C = 15A,$ $V_{GE} = 4.5V$ $T_C = 150^{\circ}C$		T <sub>C</sub> = 150°C	-	1.90	2.20	V
ynamic (	Charact	eristics								
Q <sub>G(ON)</sub>	Gate Ch			I <sub>C</sub> = 10A, V <sub>CE</sub> = 12V, V <sub>GE</sub> = 5V, See Fig. 14		-	17	-	nC	
V <sub>GE(TH)</sub>	Gate to I	Emitter Threshold Voltage		$I_C = 1.0 \text{mA},$		T <sub>C</sub> = 25°C	1.3	-	2.2	V
()				V <sub>CE</sub> = V <sub>GE</sub> , See Fig. 10	-	T <sub>C</sub> = 150°C	0.75	-	1.8	V
$V_{GEP}$	Gate to I	Emitter Plateau Voltage		$I_C = 10A, V_C$	E =	12V	-	3.0	-	V
witching	Charac	teristics								
t <sub>d(ON)R</sub>		Turn-On Delay Time-Resis	tive	$V_{CF} = 14V, R_1 = 1\Omega,$		-	0.7	4	μs	
t <sub>rR</sub>	Current Rise Time-Resistive			$V_{GE} = 5V$ , $R_G = 1K\Omega$ $T_J = 25^{\circ}C$ , See Fig. 12			_	2.1	7	μs
אור								<u></u>	<u>L</u>	
t <sub>d(OFF)L</sub>	Current 7	Turn-Off Delay Time-Induc	tive		′, L = 500µHy,		-	4.8	15	μs
t <sub>fL</sub>	Current I	Fall Time-Inductive		$V_{GE}$ = 5V, $R_G$ = 1K $\Omega$ T <sub>J</sub> = 25°C, See Fig. 12			-	2.8	15	μs
SCIS	Self Clamped Inductive Switching			$T_J$ = 25°C, L = 3.0 mHy, $R_G$ = 1K $\Omega$ , $V_{GE}$ = 5V, See Fig. 1 & 2			-	-	300	mJ
hermal C	haracte	eristics						•		•

## **Typical Performance Curves**

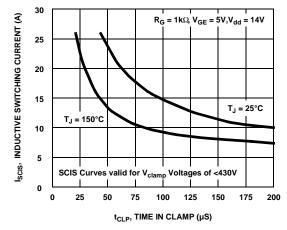


Figure 1. Self Clamped Inductive Switching Current vs Time in Clamp

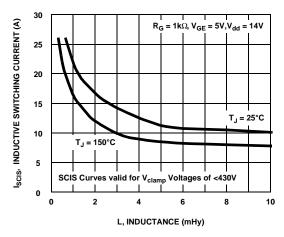


Figure 2. Self Clamped Inductive Switching Current vs Inductance

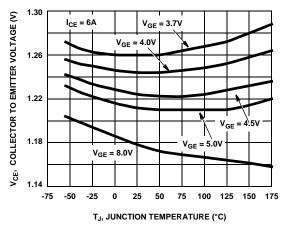


Figure 3. Collector to Emitter On-State Voltage vs Junction Temperature

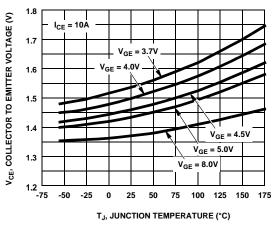


Figure 4. Collector to Emitter On-State Voltage vs Junction Temperature

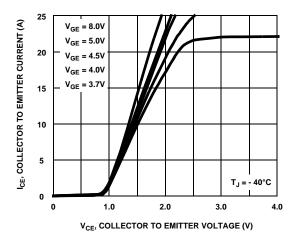


Figure 5. Collector to Emitter On-State Voltage vs Collector Current

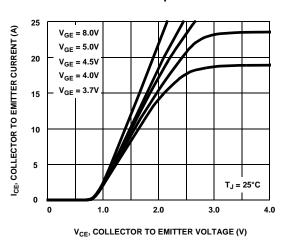


Figure 6. Collector to Emitter On-State Voltage vs Collector Current

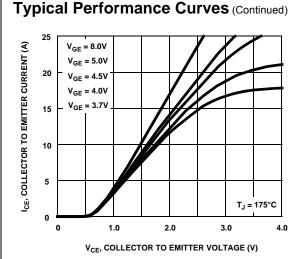


Figure 7. Collector to Emitter On-State Voltage vs Collector Current

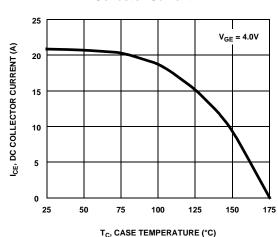


Figure 9. DC Collector Current vs Case Temperature

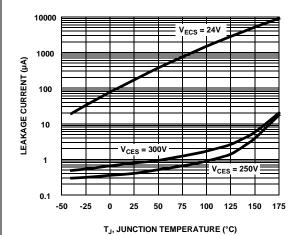


Figure 11. Leakage Current vs Junction Temperature

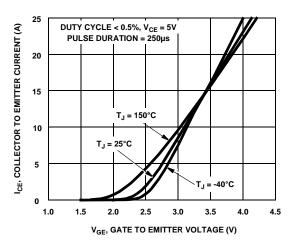


Figure 8. Transfer Characteristics

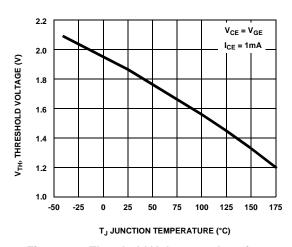


Figure 10. Threshold Voltage vs Junction Temperature

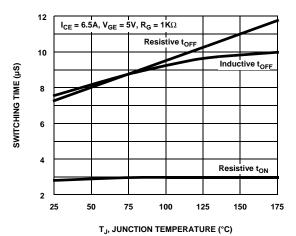
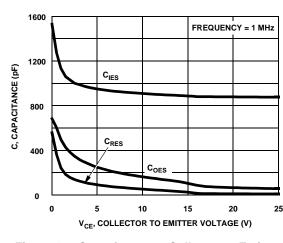


Figure 12. Switching Time vs Junction Temperature



**Typical Performance Curves** (Continued)

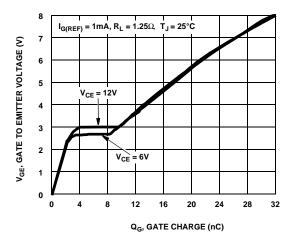


Figure 13. Capacitance vs Collector to Emitter Voltage

Figure 14. Gate Charge

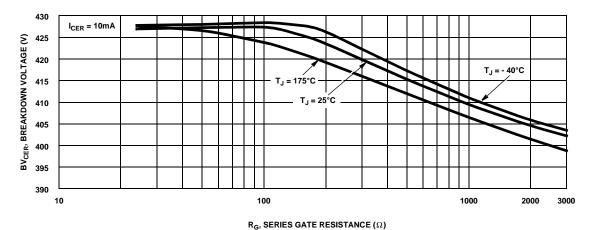


Figure 15. Breakdown Voltage vs Series Gate Resistance

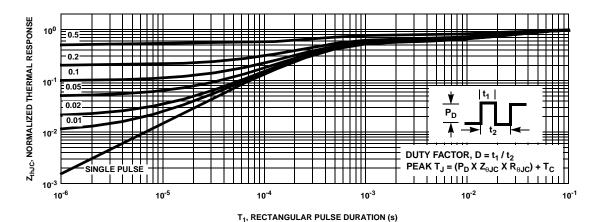


Figure 16. IGBT Normalized Transient Thermal Impedance, Junction to Case

## **Test Circuit and Waveforms**

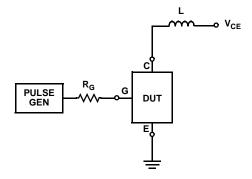


Figure 17. Inductive Switching Test Circuit

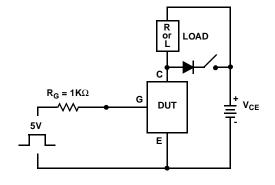


Figure 18.  $t_{ON}$  and  $t_{OFF}$  Switching Test Circuit

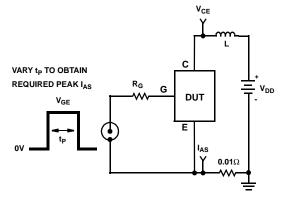


Figure 19. Energy Test Circuit

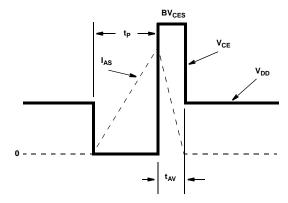


Figure 20. Energy Waveforms

#### SPICE Thermal Model REV 7 March 2002 JUNCTION ISL9V3040D3S / ISL9V3040S3S / ISL9V3040P3 / ISL9V3040S3 CTHERM1 th 6 2.1e -3 CTHERM2 6 5 1.4e -1 CTHERM3 5 4 7.3e -3 CTHERM4 4 3 2.1e -1 RTHERM1 CTHERM1 CTHERM5 3 2 1.1e -1 CTHERM6 2 tl 6.2e +6 RTHERM1 th 6 1.2e -1 6 RTHERM2 6 5 1.9e -1 RTHERM3 5 4 2.2e -1 RTHERM4 4 3 6.0e -2 RTHERM2 CTHERM2 RTHERM5 3 2 5.8e -2 RTHERM6 2 tl 1.6e -3 SABER Thermal Model 5 SABER thermal model ISL9V3040D3S / ISL9V3040S3S / ISL9V3040P3 / ISL9V3040S3 RTHERM3 CTHERM3 template thermal\_model th tl thermal\_c th, tl 4 ctherm.ctherm1 th 6 = 2.1e - 3ctherm.ctherm2 6 5 = 1.4e -1 ctherm.ctherm3 5 4 = 7.3e -3 ctherm.ctherm4 4 3 = 2.2e -1 RTHERM4 CTHERM4 ctherm.ctherm5 3 2 =1.1e -1 ctherm.ctherm6 2 tl = 6.2e +6 rtherm.rtherm1 th 6 = 1.2e -1 3 rtherm.rtherm2 6 5 = 1.9e - 1rtherm.rtherm3 5 4 = 2.2e -1 rtherm.rtherm4 4 3 = 6.0e -2 RTHERM5 CTHERM5 rtherm.rtherm5 3 2 = 5.8e -2 rtherm.rtherm6 2 tl = 1.6e -3 2 RTHERM6 CTHERM6 CASE

ON Semiconductor and in are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at <a href="www.onsemi.com/site/pdf/Patent-Marking.pdf">www.onsemi.com/site/pdf/Patent-Marking.pdf</a>. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights nor the rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor products for any such unintended or unauthorized application, Buyer shall indemnify and hol

#### **PUBLICATION ORDERING INFORMATION**

#### LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor 19521 E. 32nd Pkwy, Aurora, Colorado 80011 USA Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada Email: orderlit@onsemi.com N. American Technical Support: 800-282-9855 Toll Free USA/Canada Europe, Middle East and Africa Technical Support: Phone: 421 33 790 2910

Phone: 421 33 790 2910

Japan Customer Focus Center
Phone: 81–3–5817–1050

ON Semiconductor Website: www.onsemi.com

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative